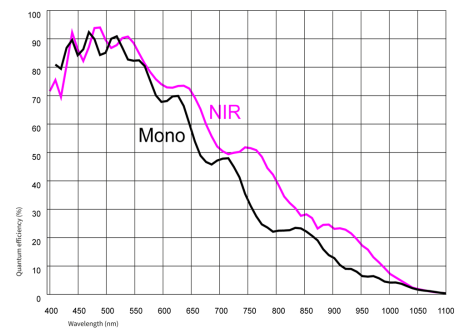


In series
The model is in series and available for the long term.



Specification

Sensor	
Sensor type	CMOS Mono
Shutter	Rolling shutter
Sensor characteristic	Linear
Pixel Class	5 MP
Resolution	5.04 Mpix
Resolution (h x v)	2592 x 1944 Pixel
Aspect ratio	4:3
ADC	12 bit
Color depth (camera)	12 bit
Optical sensor class	1/2.5"
Optical Size	5.702 mm x 4.277 mm
Optical sensor diagonal	7.13 mm 1/2.5"
Pixel size	2.2 µm
CRA (Chief Ray Angle)	9 °
Manufacturer	Onsemi
Sensor Model	AR0522SRSM09SURA0
Gain (master/RGB)	15x/-
AOI horizontal	same frame rate
AOI vertical	increased frame rate
AOI image width / step width	48 / 12
AOI image height / step width	4 / 2
AOI position grid (horizontal/vertical)	8 / 2
Binning horizontal	same frame rate
Binning vertical	increased frame rate
Binning method	Horizontal: - / Vertical: -
Binning factor	2x2
Decimation (subsampling) horizontal	same frame rate
Decimation (subsampling) vertical	increased frame rate
Decimation (subsampling) method	Color



Model

Frame rate freerun mode	48 fps
Frame rate trigger (continuous)	44 fps
Frame rate trigger (maximum)	44 fps
Exposure time (minimum - maximum)	0.01 ms - 635 ms
Power consumption	0.5 W - 1 W
Image memory	-

Ambient conditions

The temperature values given below refer to the outer device temperature of the camera housing.

Allowed device temperature during operation	0 °C - 55 °C / 32 °F - 131 °F
Allowed ambient temperature during operation	0 °C - °C / 32 °F - 32 °F
Allowed ambient temperature during storage	-20 °C - 60 °C / -4 °F - 140 °F
Humidity (relative, non-condensing)	20 % - 80 %

Connectors

Interface connector	USB 3.0 micro-B, screwable
I/O connector	8-pin Wuerth connector
Power supply	USB cable

Pin assignment I/O connector

1	Voltage output 3.3 V
2	Ground (GND)
3	Flash output without optocoupler - Line 1
4	Trigger input without optocoupler - Line 0
5	General Purpose I/O (GPIO) 1 - Line 2
6	General Purpose I/O (GPIO) 2 - Line 3
7	Ground (GND)
8	USB Power: 5 V, max. 400 mA



Design

Lens Mount	C-Mount
IP code	IP30
Dimensions H/W/L	29.0 mm x 29.0 mm x 17.0 mm
Mass	61 g
Housing material	Zinc nickel-plated

Features

List of on-camera image pre-processing features.

All features of the table are available via our IDS peak software for image pre-processing on the host computer (sensor model dependent).

Image Acquisition	Freerun	✓
	Software trigger	✓
	Hardware trigger	✓
	Trigger controlled exposure	-
	Denoiser	-
	Long exposure	-
	Line scan	-
	Global start	-
Flashing	Flashing	✓
	PWM flashing	-

Subject to technical modifications (2026-08-26)

U3-3680XCP-NIR-GL Rev.1.2 (1008730)

Image Adjustments	Auto exposure	-
	Auto gain	-
	Auto whitebalance	-
	Color correction	-
	Gamma	-
	LUT	-
	Mirror/flip	X/Y
On-board Image Processing	Pixel formats	Mono8 Mono10g40IDS Mono12g24IDS
	Region of interest	✓
	Decimation (FPGA)	-
	Decimation (Sensor)	2x(2,4)
	Binning (FPGA)	-
	Binning (Sensor)	2x2 Increases frame rate.
Others	Chunks	-
	Sequencer	-
	Events	-
	Firmware update	✓
	1st supported firmware version	3.20